CMT04 SERIES

1. PART NO. EXPRESSION:

 $\frac{\text{C M T}}{\text{(a)}} \frac{\text{0 4}}{\text{(b)}} - \frac{\text{4 0 0}}{\text{(c)}} - \frac{\text{R}}{\text{(d)(e)}} \frac{\text{A}}{\text{(f)}} - \frac{\square}{\text{(f)}}$

(a) Series code

(d) R : Reel

(b) Dimension code

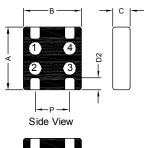
(e) Current code

(c) Impedance code : $400 = 40\Omega$

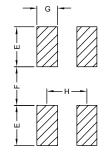
(f) 10: Standard

11~99: Internal control number

2. CONFIGURATION & DIMENSIONS:





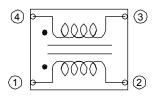


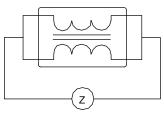
Recommended PCB Pattern

Unit:m/m

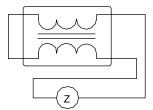
Α	В	С	Р	D1	D2	E	F	G	Н
1.25± 0.15	1.00± 0.15	0.55± 0.10	0.55± 0.10	0.30± 0.10	0.20± 0.10	0.45~0.55	0.7~0.8	0.25~0.35	0.55

3. SCHEMATIC:









Differential mode



 ${\it NOTE}$: Specifications subject to change without notice. Please check our website for latest information.



Common mode filter (RoHS Compliant) CMT04 SERIES

4. GENERAL SPECIFICATION:

a) Operating temp.: -40° C to 85° C

b) Storage condition (component in its packaging)

i) Temperature: 5 to 40° C

ii) Humidity: 60%

5. ELECTRICAL CHARACTERISTICS:

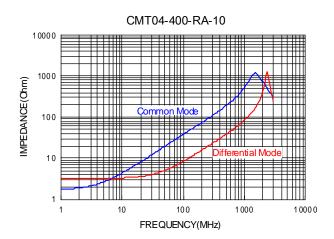
Part Number	Impedance (Ω)	Test Frequency (MHz)	DC Resistance (Ω) Max.	IDC (mA) Max.	Rated Voltage (Vdc) Max.	Insulation Resistance (MΩ) Min.
CMT04-400-RA-10	40± 25%	100	2.5	100	5	100
CMT04-900-RA-10	90± 25%	100	4.5	100	5	100

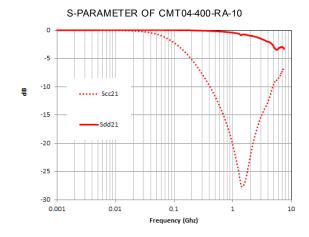


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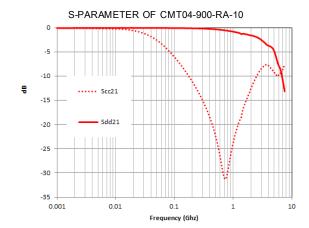
CMT04 SERIES

6. CHARACTERISTICS CURVES:





CMT04-900-RA-10 1000 1000 Common Mode Common Mode The result of the common Mode FREQUENC Y(MHz)





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CMT04 SERIES

7. SOLDERING AND MOUNTING:

7-1. Soldering

Mildly activated rosin fluxes are preferred. The terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

If wave soldering is used ,there will be some risk.

Re-flow soldering temperatures below 240 degrees, there will be non-wetting risk

7-1.1 Lead Free Solder re-flow:

Recommended temperature profiles for lead free re-flow soldering in Figure 1. (Refered to J-STD-020C)

7-1.2 Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. If a soldering iron must be employed the following precautions are recommended. for Iron Soldering in Figure 2.

Note:

- a) Preheat circuit and products to 150° C.
- b) 350° C tip temperature (max)
- c) Never contact the ceramic with the iron tip
- d) 1.0mm tip diameter (max)
- e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- f) Limit soldering time to 4-5 secs.

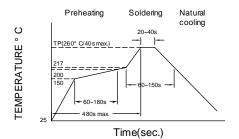


Figure 1. Re-flow Soldering: 3 times max.

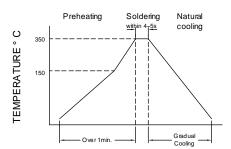
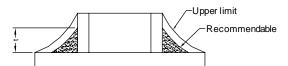


Figure 2. Iron Soldering times: 1 times max.

7-2. Solder Volume

Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance. Solder shall be used not to be exceed as shown in Fig. 4. Minimum fillet height = soldering thickness + 25% product height





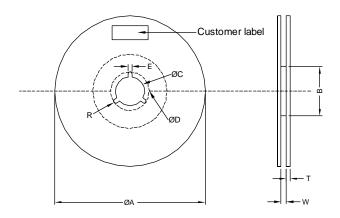
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CMT04 SERIES

8. PACKAGING INFORMATION:

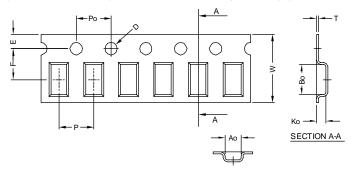
8-1. Reel Dimension



Unit:m/m

ØA	ØB	ØС	ØD	Е	W	Т	R
178± 2.0	50 Min.	13±0.2	21±0.8	2.0±0.5	10±1.5	2.5 Max.	1.0

8-2. Tape Dimension / 8mm(black anti-static electricity carrier tape)



Unit:m/m

Series	Ao	Во	D	E	F	Ko	Р	Po	Т
CMT04	1.15± 0.05	1.40± 0.05	1.5±0.1	1.75±0.1	3.5± 0.05	0.65± 0.05	4.0±0.1	4.0±0.1	0.3 Max.

8-3. Packaging Quantity

Chip size	CMT04
Chip /Reel	5000
Inner box	25000
Middle box	125000
Carton	250000

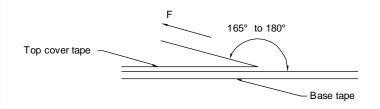
RoHS Compliant

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CMT04 SERIES

8-4. Tearing Off Force



The force for tearing off cover tape is 15 to 85 grams in the arrow direction under the following conditions.

Room Temp. (° C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed (mm/min)
5~35	45~85	860~1060	300

Application Notice

1. Storage Conditions:

To maintain the solderability of terminal electrodes:

- a) Recommended products should be used within 12 months from the time of delivery.
- b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation:

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) The use of tweezers or vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.



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